# **FEATURES**

- ► Smallest Encapsulated 50W Converter
- ► Compact Size of 2" X 1" Package
- ► Ultra-wide 4:1 Input Voltage Range
- ► Fully Regulated Output Voltage
- ► Excellent Efficiency up to 92%
- ► I/O Isolation 1500 VDC
- ▶ Operating Ambient Temp. Range -40°C to +80°C
- ► No Min. Load Requirement
- ➤ Overload/Voltage/Temp. and Short Circuit Protection
- ► Remote On/Off Control, Output Voltage Trim
- ► Shielded Metal Case with Insulated Baseplate
- ► UL/cUL/IEC/EN 62368-1(60950-1) Safety Approval & CE Marking















# PRODUCT OVERVIEW

The MINMAX MKWI50 series is the generation of high-performance DC-DC converter modules setting a new standard concerning power density. The product offers fully 50W in an encapsulated, shielded metal package with dimensions of just 2.0"x1.0"x0.4". All models provide wide 4:1 input voltage range and precisely regulated output voltages.

A very high efficiency up to 92% which allows an operating temperature range of -40°C to +80°C is achieved by advanced circuit topology. Further features include remote On/Off, trimmable output voltage, under-voltage shutdown as well as overload and over-temperature protection.

Typical applications for these converters are battery operated equipment, instrumentation, distributed power architectures in communication and industrial electronics and many other space critical applications.

Model Selection	Guide								
Model	Input	Output	Output Current	Input C	Current	Reflected	Over	Max. capacitive	Efficiency
Number	Voltage	Voltage				Ripple	Voltage	Load	(typ.)
	(Range)		Max.	@Max. Load	@No Load	Current	Protection		@Max. Load
	VDC	VDC	mA	mA(typ.)	mA(typ.)	mA(typ.)	VDC	μF	%
MKWI50-24S033		3.3	10000	1528	80		3.9	26000	90
MKWI50-24S05	0.4	5	10000	2290	60	40	6.2	17000	91
MKWI50-24S12	24	12	4170	2267	80		15	3000	92
MKWI50-24S15	(9~36)	15	3330	2263	80		18	2000	92
MKWI50-24S24		24	2080	2286	80		30	750	91
MKWI50-48S033		3.3	10000	764	40		3.9	26000	90
MKWI50-48S05	40	5	10000	1145	30		6.2	17000	91
MKWI50-48S12	48 (49, 75)	12	4170	1134	60	30	15	3000	92
MKWI50-48S15	(18~75)	15	3330	1134	60		18	2000	92
MKWI50-48S24		24	2080	1143	50		30	750	91

Input Specific	cations					
Par	ameter	Conditions / Model	Min.	Тур.	Max.	Unit
		24V Input Models	-0.7		50	
Input Surge Volta	ge (100ms. max)	48V Input Models	-0.7		100	
Start-Up Threshold Voltage		24V Input Models			9	VDC
		48V Input Models			18	
Under Voltage Lockout		24V Input Models		7.5		
		48V Input Models		16		
Input Polarity Pro	tection	N	one			
Start Up Time	Power Up	Namical Vin and Constant Designing Load			30	ms
	Remote On/Off	ote On/Off Nominal Vin and Constant Resistive Load			30	ms
Input Filter All Models Internal LC Type				LC Type		



Remote On/Off Control							
Parameter	Conditions	Min.	Тур.	Max.	Unit		
Converter On	3.5V ~ 12V or Open Circuit						
Converter Off	0V ~ 1.2V or Short Circuit						
Control Input Current (on)	Vctrl = 5.0V		0.5		mA		
Control Input Current (off)	Vctrl = 0V		-0.5		mA		
Control Common	Referenced to Negative Input						
Standby Input Current	Nominal Vin		2.5		mA		

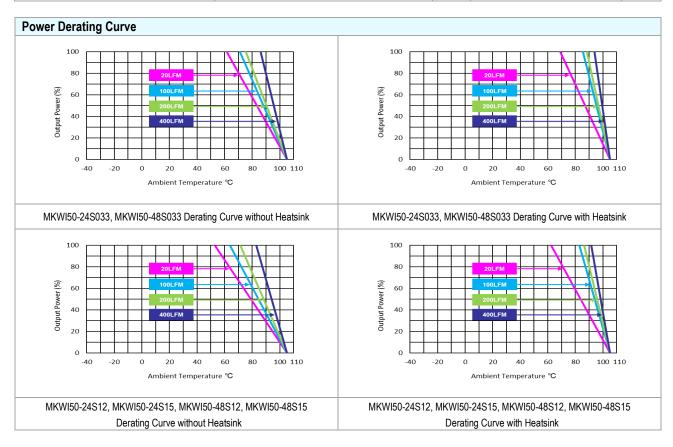
Output Specifications							
Parameter	Conditio	ns / Model	Min.	Тур.	Max.	Unit	
Output Voltage Setting Accuracy					±1.0	%Vnom.	
Line Regulation	Vin=Min. to M	lax. @Full Load			±0.5	%	
Load Regulation	Min. Load	to Full Load			±0.5	%	
Minimum Load	No minimum Load Requirement						
Divide 0 Noise	0-20 MHz Bandwidth	3.3V & 5V Models(3)			100	mV <sub>P-P</sub>	
Ripple & Noise		12V, 15V & 24V Models <sub>(3)</sub>			150	mV <sub>P-P</sub>	
Transient Recovery Time	050/ 1 10	) Ob		250		μsec	
Transient Response Deviation	25% L0a0 8	Step Change <sub>(2)</sub>		±3	±5	%	
Temperature Coefficient					±0.02	%/°C	
Tring Ha / Davis Davis (Cas Dava C)	% of nominal output			+20 / -10	%		
Trim Up / Down Range (See Page 6 )	% of nominal output			±10	%		
Over Load Protection	Hi		150		%		
Short Circuit Protection	Continuous, Automatic Recovery (Hiccup Mode 0.3Hz typ.)						

General Specifications							
Parameter	Conditions	Min.	Typ.	Max.	Unit		
I/O la alatina \/altana	60 Seconds	1500			VDC		
I/O Isolation Voltage	1 Seconds	1800			VDC		
I/O Isolation Resistance	500 VDC	500 VDC 1000			ΜΩ		
I/O Isolation Capacitance	100kHz, 1V		2200		pF		
Switching Frequency			285 kH		kHz		
MTBF(calculated)	MIL-HDBK-217F@25°C, Ground Benign		230,900 Hours				
0-64. A	UL/cUL 60950-1 recognition(CSA certificate), IEC/EN 60950-1(CB-report)						
Safety Approvals	UL/cUL 62368-1 recognition(UL certificate), IEC/EN 62368-1(CB-report)						

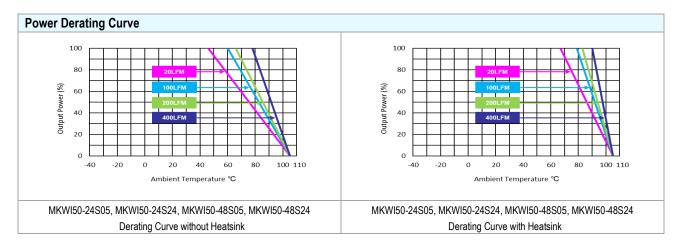
EMC Specifications							
Parameter		Standards & Level Perform					
ЕМІ	Conduction	EN 55022	With outomal components	Class A			
	Radiation	on EN 55032	With external components	Class A (6)			
	EN 55024						
	ESD	EN 61000-4-2 air ± 8kV , Contact ± 6kV		А			
EMO	Radiated immunity	EN 61000-4-3 10V/m		A			
EMS	Fast transient (7)	EN 61000-4-4 ±2kV		А			
	Surge (7)	EN 61000-4-5 ±1kV		Α			
	Conducted immunity	EN 61000-4-6 10Vrms		A			



Demonstra	Conditions / Model		Ma			
Parameter			without Heatsink	with Heatsink	Unit	
	MKWI50-24S033, MKWI50-48S033		61	69		
Operating Ambient Temperature Range	MKWI50-24S12, MKWI50-24S15		F2	62		
Nominal Vin, Load 100% Inom.	MKWI50-48S12, MKWI50-48S15	-40	53	02	°C	
(for Power Derating see relative Derating Curves)	MKWI50-24S05, MKWI50-24S24		46	<b>57</b>		
	MKWI50-48S05, MKWI50-48S24		46	57		
	20LFM Convection without Heatsink	LFM Convection without Heatsink 12.1				
	20LFM Convection with Heatsink	9.8			°C/W	
	100LFM Convection without Heatsink	9.2			°C/W	
Thermal Impedance	100LFM Convection with Heatsink	5.4			°C/W	
Thermal Impedance	200LFM Convection without Heatsink	7.8			°C/W	
	200LFM Convection with Heatsink	4.5			°C/W	
	400LFM Convection without Heatsink	5.2			°C/W	
	400LFM Convection with Heatsink	3.0			°C/W	
Case Temperature			+10	05	°C	
Thermal Protection	Shutdown Temperature		110°C	typ.		
Storage Temperature Range		-50	+12	25	°C	
Humidity (non condensing)			9:	5	% rel. H	
RFI	Six-Sided Shielded, Metal Case					
Lead Temperature (1.5mm from case for 10Sec.)			26	0	°C	







## **Notes**

- 1 Specifications typical at Ta=+25°C, resistive load, nominal input voltage, rated output current unless otherwise noted.
- 2 Transient recovery time is measured to within 1% error band for a step change in output load of 75% to 100%.
- 3 Ripple & Noise measurement with a 1µF MLCC and a 10µF Tantalum Capatitor.
- We recommend to protect the converter by a slow blow fuse in the input supply line.
- 5 Other input and output voltage may be available, please contact MINMAX.
- 6 The standard module meets EN 55032 Class A with external components. For further information, please contact MINMAX.
- 7 To meet EN 61000-4-4 & EN 61000-4-5 an external filter requested, please contact MINMAX.
- 8 Do not exceed maximum power specification when adjusting output voltage.
- 9 Specifications are subject to change without notice.



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Pin Connec	Pin Connections					
Pin	Function					
1	+Vin					
2	-Vin					
3	Remote On/Off					
4	+Vout					
5	-Vout					
6	Trim					

- ► All dimensions in mm (inches)
- ► Tolerance : X.X±0.25 (X.XX±0.01)

X.XX±0.13 (X.XXX±0.005)

► Pin diameter Ø 1.0 ±0.05 (0.04±0.002)

# **Physical Characteristics**

Case Size : 50.8x25.4x11.0mm (2.0x1.0x0.43 inches)

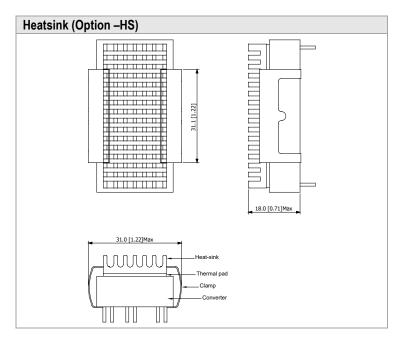
Case Material : Aluminium Alloy, Black Anodized Coating

Base Material : FR4 PCB (flammability to UL 94V-0 rated)

Pin Material : Copper Alloy with Gold Plate Over Nickel Subplate

Potting Material : Epoxy (UL94-V0)

Weight : 34g



Physical Characteristics

Heatsink Material : Aluminum

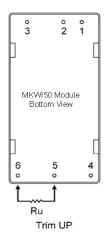
Finish : Black Anodized Coating

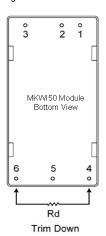
Weight : 9g

- ► The advantages of adding a heatsink are:
- To improve heat dissipation and increase the stability and reliability of the DC-DC converters at high operating temperatures.
- 2. To increase operating temperature of the DC-DC converter, please refer to Derating Curve.

# **External Output Trimming**

Output can be externally trimmed by using the method shown below

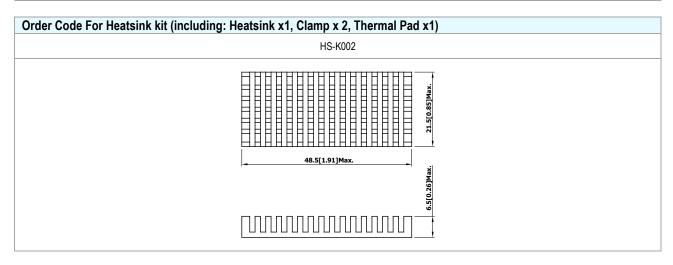




	MKWI50	-XXS033	MKWI50	-XXS05	MKWI50	-XXS12	MKWI50	-XXS15	MKWI50	-XXS24
Trim Range	Trim down	Trim up								
(%)	(kΩ)	(kΩ)								
1	72.61	60.84	138.88	106.87	413.55	351.00	530.73	422.77	333.39	
2	32.55	27.40	62.41	47.76	184.55	157.50	238.61	189.89	148.80	243.70
3	19.20	16.25	36.92	28.06	108.22	93.00	141.24	112.26	87.26	
4	12.52	10.68	24.18	18.21	70.05	60.75	92.56	73.44	56.50	108.50
5	8.51	7.34	16.53	12.30	47.15	41.40	63.35	50.15	38.04	
6	5.84	5.11	11.44	8.36	31.88	28.50	43.87	34.63	25.73	63.43
7	3.94	3.51	7.79	5.55	20.98	19.29	29.96	23.54	16.94	
8	2.51	2.32	5.06	3.44	12.80	12.37	19.53	15.22	10.35	40.90
9	1.39	1.39	2.94	1.79	6.44	7.00	11.41	8.75	5.22	
10	0.50	0.65	1.24	0.48	1.35	2.70	4.92	3.58	1.12	27.38
12										18.37
14										11.93
16										7.10
18										3.34
20										0.34



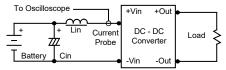
Order Code Table					
Standard	With heatsink				
MKWI50-24S033	MKWI50-24S033-HS				
MKWI50-24S05	MKWI50-24S05-HS				
MKWI50-24S12	MKWI50-24S12-HS				
MKWI50-24S15	MKWI50-24S15-HS				
MKWI50-24S24	MKWI50-24S24-HS				
MKWI50-48S033	MKWI50-48S033-HS				
MKWI50-48S05	MKWI50-48S05-HS				
MKWI50-48S12	MKWI50-48S12-HS				
MKWI50-48S15	MKWI50-48S15-HS				
MKWI50-48S24	MKWI50-48S24-HS				



## **Test Setup**

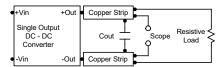
#### Input Reflected-Ripple Current Test Setup

Input reflected-ripple current is measured with a inductor Lin  $(4.7\mu\text{H})$  and Cin  $(220\mu\text{F}, \text{ESR} < 1.0\Omega \text{ at }100 \text{ kHz})$  to simulate source impedance. Capacitor Cin, offsets possible battery impedance. Current ripple is measured at the input terminals of the module, measurement bandwidth is 0-500 kHz.



#### Peak-to-Peak Output Noise Measurement Test

Refer to the output specifications or add 4.7µF capacitor if the output specifications undefine Cout. Scope measurement should be made by using a BNC socket, measurement bandwidth is 0-20 MHz. Position the load between 50 mm and 75 mm from the DC-DC Converter.



## **Technical Notes**

#### Remote On/Off

Positive logic remote on/off turns the module on during a logic high voltage on the remote on/off pin, and off during a logic low. To turn the power module on and off, the user must supply a switch to control the voltage between the on/off terminal and the -Vin terminal. The switch can be an open collector or equivalent. A logic low is 0V to 1.2V. A logic high is 3.5V to 12V. The maximum sink current at the on/off terminal (Pin 3) during a logic low is -100µA.

#### Overload Protection

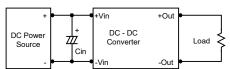
To provide hiccup mode protection in a fault (output overload) condition, the unit is equipped with internal current limiting circuitry and can endure overload for an unlimited duration

#### Overvoltage Protection

The output overvoltage clamp consists of control circuitry, which is independent of the primary regulation loop, that monitors the voltage on the output terminals. The control loop of the clamp has a higher voltage set point than the primary loop. This provides a redundant voltage control that reduces the risk of output overvoltage. The OVP level can be found in the output data.

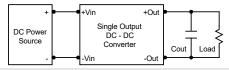
# Input Source Impedance

The power module should be connected to a low ac-impedance input source. Highly inductive source impedances can affect the stability of the power module. In applications where power is supplied over long lines and output loading is high, it may be necessary to use a capacitor at the input to ensure startup. Capacitor mounted close to the power module helps ensure stability of the unit, it is recommended to use a good quality low Equivalent Series Resistance (ESR < 1.0Ω at 100 kHz) capacitor of a 10μF for the 24V and 48V devices.



## Output Ripple Reduction

A good quality low ESR capacitor placed as close as practicable across the load will give the best ripple and noise performance. To reduce output ripple, it is recommended to use 4.7µF capacitors at the output.



# Maximum Capacitive Load

The MKWI50 series has limitation of maximum connected capacitance at the output. The power module may be operated in current limiting mode during start-up, affecting the ramp-up and the startup time. The maximum capacitance can be found in the data sheet.

### Thermal Considerations

Many conditions affect the thermal performance of the power module, such as orientation, airflow over the module and board spacing. To avoid exceeding the maximum temperature rating of the components inside the power module, the case temperature must be kept below 105°C. The derating curves are determined from measurements obtained in a test setup.

